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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







1. General description

Dual common cathode high-speed switching diode encapsulated in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- High switching speed: t_{rr} ≤ 4 ns
- Low leakage current: I_R ≤ 0.5 μA
- Reverse voltage V_R ≤ 100 V
- Low capacitance C_d ≤ 1.5 pF
- Ultra small SMD plastic package
- Low package height of 0.37 mm
- AEC-Q101 qualified
- Suitable for Automatic Optical Inspection (AOI) of solder joint

3. Applications

- · High-speed switching
- · General-purpose switching

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diode							
I _F	forward current	T _{amb} = 25 °C; single diode loaded	[1]	-	-	300	mA
V _R	reverse voltage	T _j = 25 °C		-	-	100	V
I _R	reverse current	V _R = 80 V; T _j = 25 °C		-	-	0.5	μΑ
t _{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; $I_{R(meas)}$ = 1 mA; R_L = 100 Ω ; T_{amb} = 25 °C		-	-	4	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



Dual common cathode high-speed switching diode

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)		
2	A2	anode (diode 2)		A1 D1
3	CC	common cathode	4 3	cc
4	CC	common cathode	Transparent top view DFN1010D-3 (SOT1215)	A2

6. Ordering information

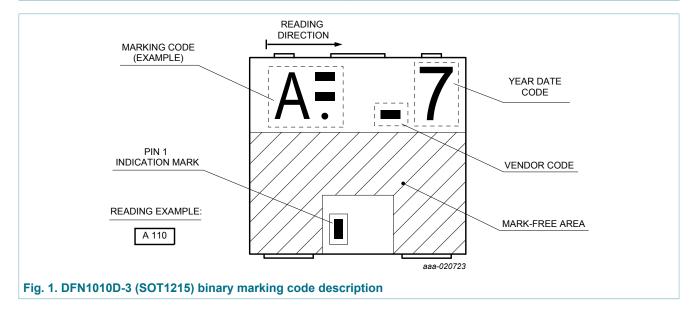
Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
BAV70QA	DFN1010D-3	DFN1010D-3: plastic thermal enhanced ultra thin small outline package; no leads; 3 terminals; body 1.1 x 1.0 x 0.37 mm	SOT1215			

7. Marking

Table 4. Marking codes

Type number	Marking code
BAV70QA	Z 010



Dual common cathode high-speed switching diode

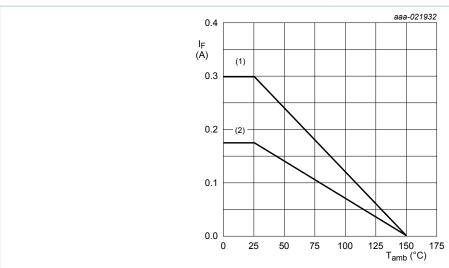
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode				,		
V _R	reverse voltage	T _j = 25 °C		-	100	V
V_{RRM}	repetitive peak reverse voltage			-	100	V
I _F	forward current	T _{amb} = 25 °C; single diode loaded	[1]	-	300	mA
		T _{amb} = 25 °C; double diode loaded	[1]	-	175	mA
I _{FRM}	repetitive peak forward current	$t_p \le 0.5 \text{ ms}; \delta \le 0.25 ; T_j = 25 \text{ °C}$		-	1	Α
I _{FSM}	non-repetitive peak	t_p = 100 µs; $T_{j(init)}$ = 25 °C; square wave		-	4	Α
	forward current	t_p = 1 ms; $T_{j(init)}$ = 25 °C; square wave		-	1.5	Α
		t _p = 1 s; T _{j(init)} = 25 °C; square wave		-	0.5	Α
Per device;	one diode loaded					
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	325	mW
			[2]	-	540	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².



- (1) single diode loaded
- (2) double diode loaded

Fig. 2. Forward current as a function of ambient temperature; derating curve

Dual common cathode high-speed switching diode

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
1 f	thermal resistance from junction to ambient		[1]	-	-	385	K/W
			[2]	-	-	230	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[3]	-	-	50	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [3] Soldering point of cathode tab.

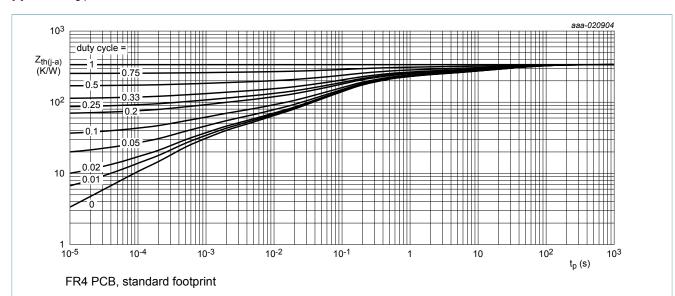


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

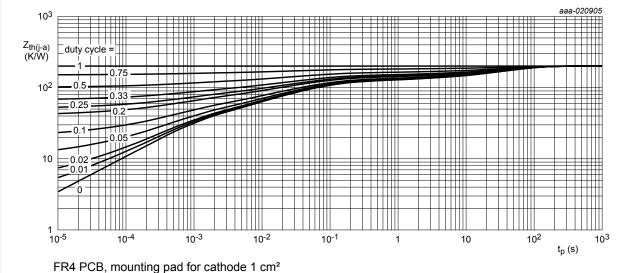


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

Dual common cathode high-speed switching diode

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V_{F}	forward voltage	I _F = 1 mA; T _j = 25 °C	-	-	715	mV
		I _F = 10 mA; T _j = 25 °C	-	-	855	mV
		I _F = 50 mA; T _j = 25 °C	-	-	1	V
		I _F = 150 mA; T _j = 25 °C	-	-	1.25	V
I _R	reverse current	V _R = 25 V; T _j = 25 °C	-	-	30	nA
		V _R = 80 V; T _j = 25 °C	-	-	0.5	μA
		V _R = 25 V; T _j = 150 °C	-	-	30	μA
		V _R = 80 V; T _j = 150 °C	-	-	100	μA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; T _j = 25 °C	-	-	1.5	pF
t _{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; $I_{R(meas)}$ = 1 mA; R_L = 100 Ω ; T_{amb} = 25 °C	-	-	4	ns
V_{FR}	forward recovery voltage	$I_F = 10 \text{ mA}; t_r = 20 \text{ ns}; T_{amb} = 25 \text{ °C}$	-	-	1.75	V

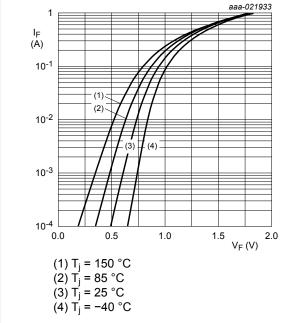


Fig. 5. Forward current as a function of forward voltage; typical values

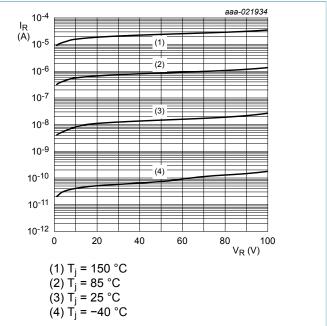


Fig. 6. Reverse current as a function of reverse voltage; typical values

Dual common cathode high-speed switching diode

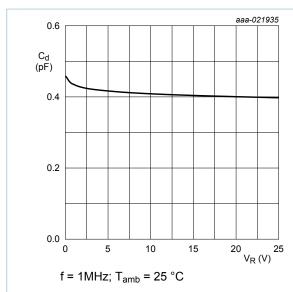


Fig. 7. Diode capacitance as a function of reverse voltage; typical values

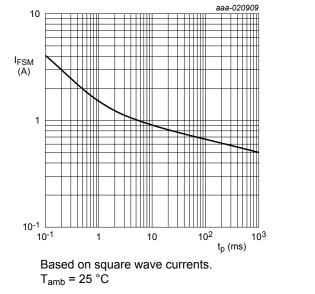
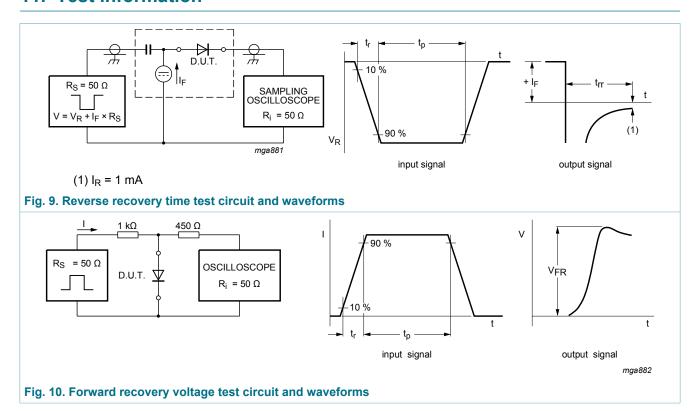


Fig. 8. Non-repetitive forward current as a function of pulse duration; maximum values

6 / 12

Dual common cathode high-speed switching diode

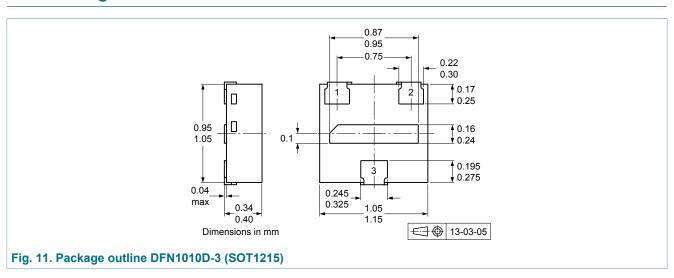
11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

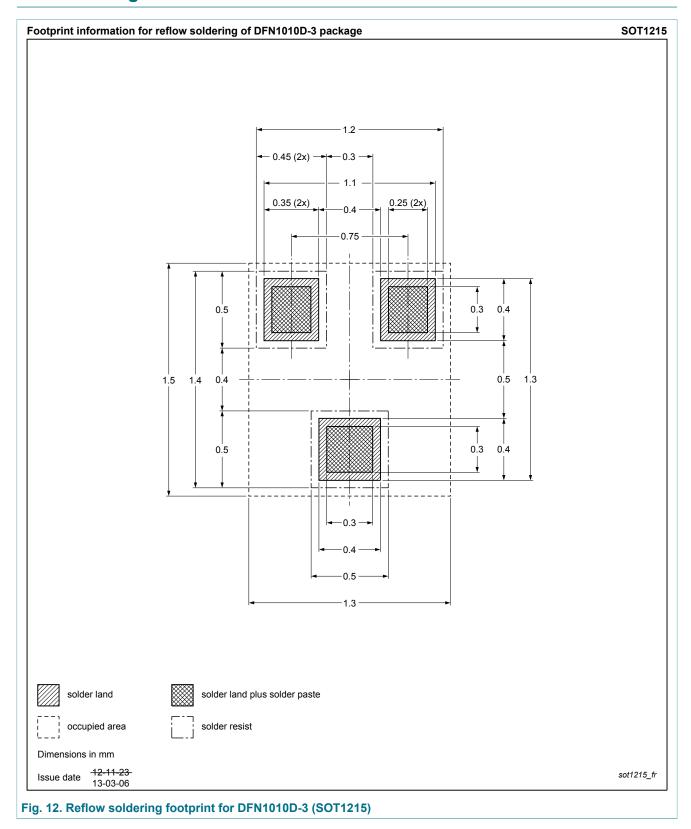
12. Package outline



BAV70QA

Dual common cathode high-speed switching diode

13. Soldering



Dual common cathode high-speed switching diode

14. Revision history

Table 8. Revision history

Tubic of Horioton in	otor y							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
BAV70QA v.2	20160504	Product data sheet	-	BAV70QA v.1				
Modification:		Characteristics table: corrected typing error, replaced parameter peak forward recovery voltage V _{FRM} with forward recovery voltage V _{FR}						
BAV70QA v.1	20160217	Product data sheet	-	-				

9 / 12

Dual common cathode high-speed switching diode

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Dual common cathode high-speed switching diode

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Dual common cathode high-speed switching diode

16. Contents

General description	1
Features and benefits	1
Applications	1
Quick reference data	1
Pinning information	2
Ordering information	2
Marking	2
Limiting values	3
Thermal characteristics	4
. Characteristics	5
Test information	7
Package outline	7
_	
-	
	General description Features and benefits Applications Quick reference data Pinning information Ordering information Marking Limiting values Thermal characteristics Characteristics Test information Package outline Soldering. Revision history Legal information

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12 / 12

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